

General Description

The MAX5426 is a precision resistor network optimized for use with programmable instrumentation amplifiers. The MAX5426 operates from dual ±5V to ±15V supplies and consumes less than 40µA of supply current. Designed to be used in the traditional three op amp instrumentation amplifier topology, this device provides noninverting gains of 1, 2, 4, and 8 that are accurate to 0.025% (A-grade), 0.09% (B-grade), or 0.5% (C-grade) over the extended temperature range (-40°C to +85°C). The MAX5426 is available in the 6.4mm x 5mm 14-pin TSSOP package.

Applications

General-Purpose Programmable Instrumentation **Amplifiers**

Gain Control in RF Power Amplifiers Precision Dual Attenuator

Features

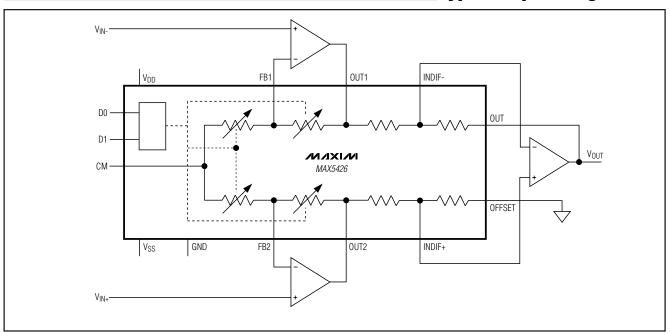
- ◆ Differential Gains: Ay = 1, 2, 4, 8
- ♦ Gain Accurate to 0.025%, 0.09%, or 0.5%
- ♦ Dual Supply ±5V to ±15V Operation
- ♦ Low 36µA Supply Current
- ♦ Simple CMOS/TTL Logic Compatible 2-Wire **Parallel Interface**
- ♦ Space-Saving 14-Pin TSSOP Package $(6.4mm \times 5mm)$
- ♦ OFFSET Pin Available to Offset the Output of the **Differential Amplifier**

Ordering Information

PART	TEMP RANGE	PIN- PACKAGE	GAIN
MAX5426AEUD	-40°C to +85°C	14 TSSOP	0.025%
MAX5426BEUD	-40°C to +85°C	14 TSSOP	0.09%
MAX5426CEUD	-40°C to +85°C	14 TSSOP	0.5%

Pin Configuration and Functional Diagram appear at end of data sheet.

Typical Operating Circuit



MIXIM

Maxim Integrated Products 1

ABSOLUTE MAXIMUM RATINGS

V _{DD} to GND	0.3V to +17V
V _{SS} to GND	17V to +0.3V
D0, D1 to GND	0.3V to $(V_{DD} + 0.2V)$
D0, D1 to GND $(V_{DD} > +6V)$	0.3V to +6.0V
All Other Pins to GND	(V_{SS} - 0.3V) to (V_{DD} + 0.2V)
Maximum Current Into VDD, VSS,	D1, D0±50mA
Maximum Current from OUT1 to	CM or OUT2±0.72mA

Maximum Current from OUT1 to INDIF- or OU	T±0.72mA
Maximum Current from OUT2 to INDIF+ or OF	FSET±0.72mA
Continuous Power Dissipation ($T_A = +70^{\circ}C$)	
14-Pin TSSOP (derate 9.1mW/°C above +70)°C)727mW
Operating Temperature Range	40°C to +85°C
Junction Temperature	+150°C
Storage Temperature Range	60°C to +150°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $(V_{DD} = +15V, V_{SS} = -15V, GND = 0, T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted. Typical values are at $T_A = +25^{\circ}C$.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
		MAX5426A		0.004	0.025		
Gain Range Accuracy (Notes 1, 2)		MAX5426B		0.025	0.090	%	
		MAX5426C		0.080	0.500		
Capacitance at Analog Pins	Canalog			5		рF	
		Gain = 1		79			
Differential CMRR (Notes 1, 2)		Gain = 2		85		dB	
Differential Civinn (Notes 1, 2)		Gain = 4		91		ив	
		Gain = 8		97			
DIGITAL INPUTS							
Input High Voltage	VIH		2.4			V	
Input Low Voltage	VIL				0.8	V	
Input Leakage Current	I _{LKG}	D1 = D0 = 0 or logic high			10	μΑ	
EQUIVALENT RESISTANCES							
Resistance Between OUT1 and OUT2	ROUT1, ROUT2			56		kΩ	
Resistance Between OUT1 and INDIF-	ROUT1, RINDIF-			26		kΩ	
Resistance Between INDIF- and OUT	RINDIF-, ROUT			26		kΩ	
Resistance Between OUT2 and INDIF+	ROUT2, RINDIF+			26		kΩ	
Resistance Between INDIF+ and OFFSET	R _{INDIF+} , ROFFSET			26		kΩ	
		Gain = 1		0			
Resistance Between OUT1 and		Gain = 2	İ	15		1.0	
FB1	ROUT1, RFB1	Gain = 4		22		kΩ	
		Gain = 8		26			

ELECTRICAL CHARACTERISTICS (continued)

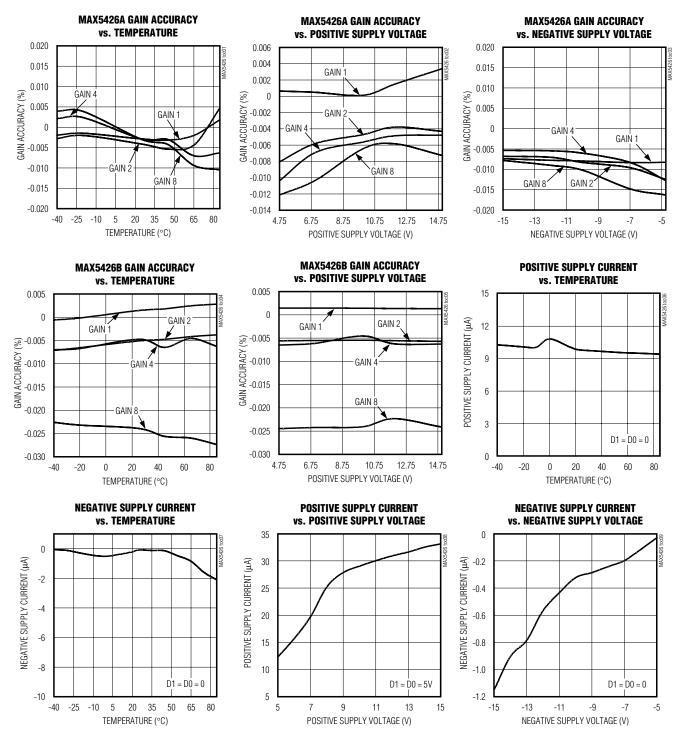
 $(V_{DD} = +15V, V_{SS} = -15V, GND = 0, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted. Typical values are at } T_A = +25^{\circ}C.)$

PARAMETER	SYMBOL	CONDITIONS	MIN TYP M	AX UNITS
	R _{FB1} , R _{FB2}	Gain = 2	29	
Resistance Between FB1 and FB2 (Note 3)		Gain = 4	15	kΩ
(14016-3)		Gain = 8	7	
		Gain = 1	0	
Resistance Between OUT2 and	Douge Dena	Gain = 2	15	kΩ
FB2	R _{OUT2} , R _{FB2}	Gain = 4	22	K22
		Gain = 8	26	
Input Impedance at FB1	Z _{FB1}		0	kΩ
Input Impedance at FB2	Z _{FB2}		0	kΩ
		Gain = 1	0	
Input Impedance at OUT1	70.174	Gain = 2	9.5	kΩ
(Note 4)	Z _{OUT1}	Gain = 4	12	K22
		Gain = 8	13	
		Gain = 1	0	
Input Impedance at OUT2	Z _{OUT2}	Gain = 2	9.5	kΩ
(Note 4)		Gain = 4	12	NS2
		Gain = 8	13	
Input Impedance at INDIF+ (Note 4)	Z _{INDIF+}		0	kΩ
Input Impedance at INDIF- (Note 4)	Z _{INDIF} -		0	kΩ
Input Impedance at OUT (Note 4)	Zout		26	kΩ
Input Impedance at OFFSET (Note 4)	Zoffset		26	kΩ
POWER REQUIREMENTS	I		1	l .
Positive Power-Supply Voltage	V_{DD}		4.75	5.75 V
Negative Power-Supply Voltage	V _{SS}		-15.75 -4	.75 V
D ::: 0 1 0 1	I _{DD}	D1 = D0 = 0	10	
Positive Supply Current		D1 = D0 = 5V	36	μA
Negative Supply Current	I _{SS}		0.01	10 μΑ
TIMING REQUIREMENTS			·	•
Switching Time (Note 5)	tswitching	(Figure 3)	60	ns

- **Note 1:** Total error when configured as instrumentation amplifier. Assumes ideal op amps.
- Note 2: Each stage (input stage and output stage) is tested for accuracy separately and combined to give the total gain accuracy. The input stage is tested as follows: OUT1 = 10V, OUT2 = 0. Output stage is tested as follows: OUT1 = 10V, OUT2 = 0 and OUT2 = 10V, OFFSET = 0.
- Note 3: Gain of 1 configuration is open circuit (infinite impedance).
- Note 4: Equivalent load at each pin is calculated according to instrumentation amplifier configuration and assumes ideal op amps.
- Note 5: See Timing Diagram.

Typical Operating Characteristics

 $(V_{DD} = +15V, V_{SS} = -15V, T_A = +25$ °C, unless otherwise noted.)



Pin Description

PIN	NAME	FUNCTION			
1	V_{DD}	Positive Power Supply. Bypass V _{DD} to GND with a 0.1µF capacitor.			
2	GND	Ground			
3	V _{SS}	Negative Power Supply. Bypass VSS to GND with a 0.1µF capacitor.			
4	FB2	First Stage Positive Input Terminal Resistor. Connect to the inverting terminal of the second input buffer (see Figure 1).			
5	OUT2	First Stage Positive Output Terminal Resistor. Connect to the output terminal of the second input buffer.			
6	OFFSET	Second Stage Offset Terminal. Connect to a DC voltage to offset the output of the differential amplifier.			
7	INDIF-	Second Stage Negative Input Terminal Resistor. Connect to the inverting input terminal of the differential op amp.			
8	INDIF+	Second Stage Positive Input Terminal Resistor. Connect to the noninverting input terminal of the differential op amp.			
9	OUT	Second Stage Output Terminal, Final Output Terminal			
10	OUT1	First Stage Negative Output Terminal of Resistor. Connect to the output terminal of the first input buffer.			
11	FB1 First Stage Negative Input Terminal of Resistor. Connect to the inverting input terminal of the first input buffer.				
12	СМ	Common-Mode Voltage. CM is the input common-mode voltage of the instrumentation amplifier. Typically varies ±1% of input common-mode voltage.			
13, 14	D0, D1	Digital Inputs. See Table 1.			

Detailed Description

The MAX5426 is a precision resistor network with low temperature drift and high accuracy that performs the same function as a precision resistor array and CMOS switches. Operationally, this device consists of fixed resistors and digitally controlled variable resistors that provide differential gains of 1, 2, 4, and 8 (see *Functional Diagram*). The MAX5426 provides gains accurate to 0.025% (MAX5426A), 0.09% (MAX5426B) or 0.5% (MAX5426C).

The MAX5426 is ideal for programmable instrumentation amplifiers. An offset pin is available to apply a DC offset voltage to the output of the differential amplifier. Pin CM is the common-mode input voltage and can be buffered and connected to the common-mode input of the instrumentation amplifier (usually the shield of the input cable to reduce the effects of cable capacitance and leakage).

Digital Interface Operation

The MAX5426 features a simple two-bit parallel programming interface. D1 and D0 program the gain setting according to the *Logic-Control Truth Table* (see Table 1). The digital interface is CMOS/TTL logic compatible.

Timing Diagram

Figure 3 shows the timing diagram of MAX5426 for two cases. In case 1, the differential input changes are at OUT1 and OUT2, while the voltage settling is observed at FB1 and FB2. The settling time (tsettle) is defined as the time for the output voltage (from the change in the input) to reach (and stay) within 0.02% of its final value.

In case 2, the differential inputs (OUT1 and OUT2) are at constant voltages, while D1 and D0 are varied (for example from 01 to 10) to make a change in the gain. No op amps are used in these cases.

Table 1. Logic-Control Truth Table

DIGITAL INPUTS		
D1	D0	GAIN
0	0	1
0	1	2
1	0	4
1	1	8

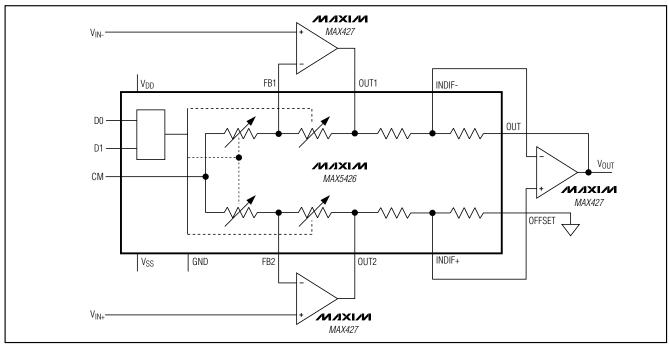


Figure 1. Programmable Instrumentation Amplifier Using MAX5426

Applications Information

The MAX5426 is ideal for programmable instrumentation amplifier applications. The typical application circuit of Figure 1 uses the MAX5426 in classical instrumentation amplifier configurations. Two digital inputs set the gain to 1, 2, 4, or 8.

Op Amp Selection Guidelines

Selection of an op amp for instrumentation amplifier circuits depends on the accuracy requirements of the specific application. General guidelines are to choose an op amp with sufficient open-loop gain, low input-off-set voltage, and a high common-mode rejection ratio.

High open-loop gain is needed to increase the gain accuracy, while low input-offset voltage and low input-offset current help meet gain and offset requirements.

Other parameters such as low input capacitance, low input bias current, high input common-mode range, and low noise often need to be considered for a wide input voltage range stability and AC considerations. The MAX427 is an excellent choice to use with the MAX5426.

Stereo Audio-Taper Attenuator

Figure 2 shows the application of the MAX5426 as a dual attenuator that can be used in stereo audio systems.

Power Supplies and Bypassing

The MAX5426 operates from dual $\pm 5V$ to $\pm 15V$ supplies. In many applications the MAX5426 does not require bypassing. If power-supply noise is excessive, bypass V_{DD} and V_{SS} with 0.1 μ F ceramic capacitors to GND.

Layout Concerns

For best performance, reduce parasitic board capacitance by minimizing the circuit board trace from amplifier outputs to inverting inputs. Also choose op amps with low input capacitance.

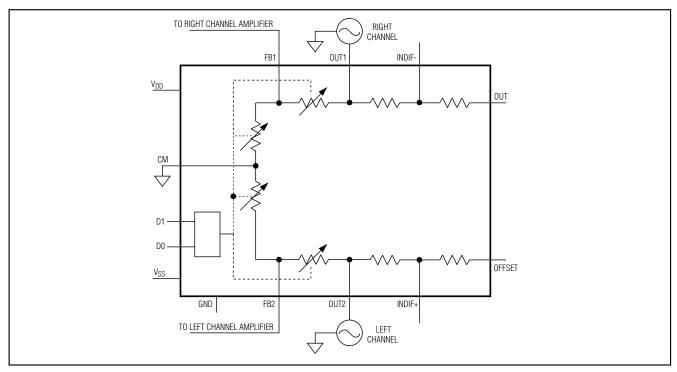


Figure 2. Stereo Audio-Taper Attenuator

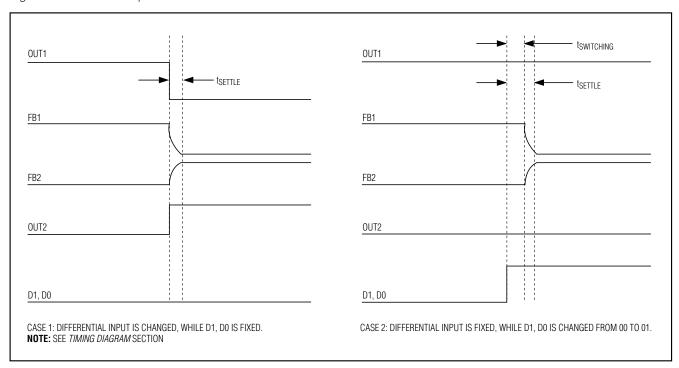
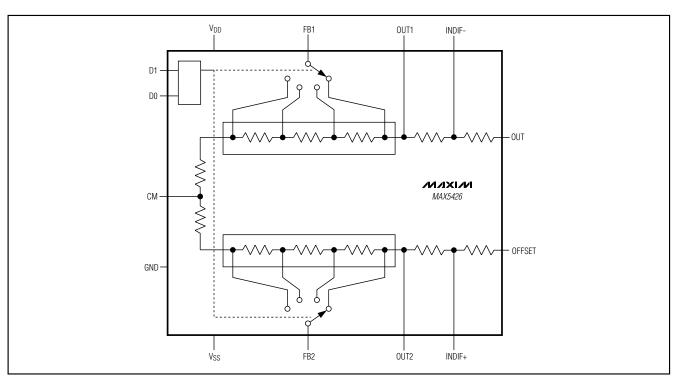


Figure 3. Timing Diagram

Functional Diagram



Pin Configuration

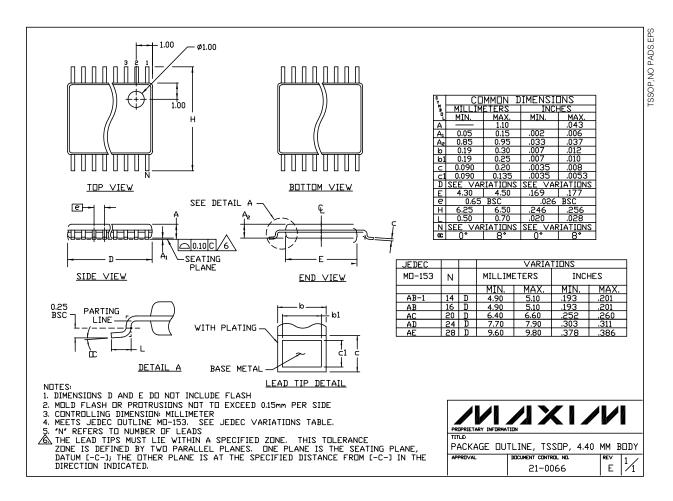
TOP VIEW 14 D1 V_{DD} 1 13 D0 GND 2 V_{SS} 3 MIXIM FB2 4 MAX5426 11 FB1 0UT2 5 10 OUT1 OFFSET 6 9 OUT 8 INDIF+ INDIF- 7

Chip Information

TRANSISTOR COUNT: 126

PROCESS TECHNOLOGY: BICMOS

Package Information



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